



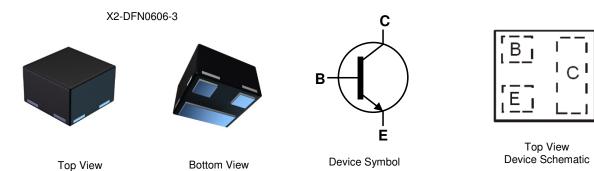
45V NPN SMALL SIGNAL TRANSISTOR IN DFN0606

Features

- BV_{CEO} > 45V
- I_C = 100mA High Collector Current
- P_D = 925mW Power Dissipation
- 0.36mm² Package Footprint, 40% Smaller than DFN1006
- 0.4mm Height Package Minimizing Off-Board Profile
- Complementary PNP Type BC857BZ
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X2-DFN0606-3
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.0008 grams (Approximate)



Ordering Information (Note 4)

Product	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
BC847BFZ-7B	1F	7	8mm	10,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

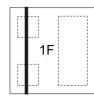
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:

X2-DFN0606-3



Top View Bar Denotes Base and Emitter Side 1F = Product Type Marking Code



Absolute Maximum Ratings (@TA = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	50	V
Collector-Emitter Voltage	V _{CEO}	45	V
Emitter-Base Voltage	V _{EBO}	6.0	V
Continuous Collector Current	IC	100	mA
Peak Pulse Collector Current	I _{CM}	200	mA

Thermal Characteristics (@T_A = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Power Dissipation	(Note 5)	D	270	mW	
	(Note 6)		925	111VV	
Thermal Desistance, Junction to Ambient	(Note 5)	_	465	- °C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	R _{θJA}	135		
Thermal Resistance, Junction to Lead (Note 7)		R _{θJL}	135	°C/W	
Operating and Storage and Temperature Ran	T _J , T _{STG}	-55 to +150	°C		

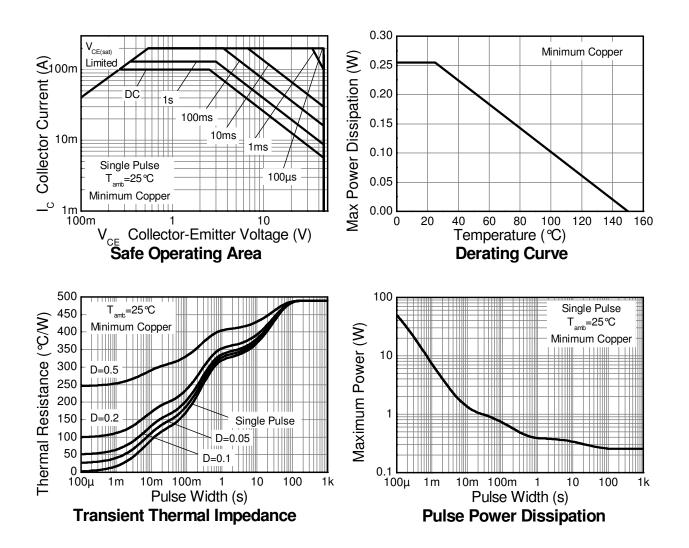
ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	200	V	В

Notes: 5. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured So the device mounted of minimum recommended pad layout roz copper that is on a single-sided 1.5mm rr4 rCs, device is under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.
Same as Note 5, except the exposed collector pad is mounted on 25mm x 25mm 2oz copper.
Thermal resistance from junction to solder-point (on the exposed collector pad).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





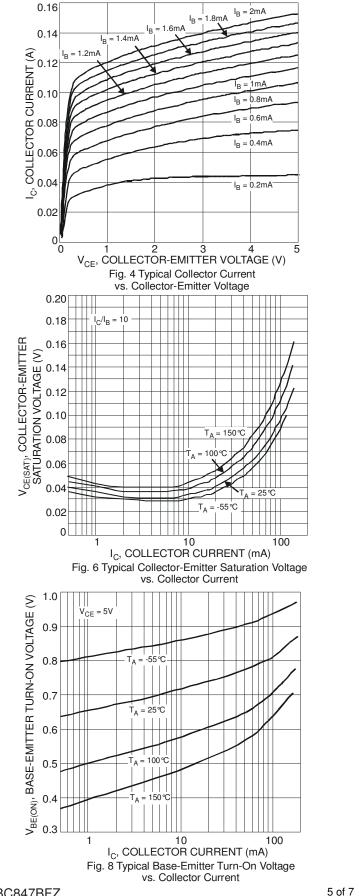
Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Min	Typical	Max	Unit	Test Condition
DFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	50	150	—	V	$I_{C} = 50 \mu A, I_{B} = 0$
Collector-Emitter Breakdown Voltage	BV _{CES}	50	150			$I_{\rm C} = 50 \mu A, I_{\rm B} = 0$
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	45	65	_	V	$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$
Collector-Base Breakdown Voltage	BV _{EBO}	6.0	8.35	_	V	$I_E = 50 \mu A, I_C = 0$
Collector-Base Cutoff Current	I _{CBO}		—	15	nA	$V_{CB} = 40V$
Collector-Emitter Cutoff Current	I _{CES}		_	15	nA	$V_{CE} = 40V$
ON CHARACTERISTICS (Note 9)	ON CHARACTERISTICS (Note 9)					
DC Current Gain	h _{FE}	 200	220 260	 470		$ I_{C} = 10 \mu A, V_{CE} = 5.0 V $
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	50 122	125 300	mV	$I_{C} = 10mA, I_{B} = 0.5mA$ $I_{C} = 100mA, I_{B} = 5.0mA$
Base-Emitter Saturation Voltage	V _{BE(sat)}	_	760 880	1,000 1,100	mV	$I_{C} = 10mA, I_{B} = 0.5mA$ $I_{C} = 100mA, I_{B} = 5.0mA$
Base-Emitter Voltage	V _{BE(on)}	580 —	650 725	750 800	mV	$ I_{C} = 2.0 mA, V_{CE} = 5V \\ I_{C} = 10 mA, V_{CE} = 5V $
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	Cobo	_	1.3	_	pF	$V_{CB} = 10.0V, f = 1.0MHz, I_E = 0$
Current Gain-Bandwidth Product	f _T	100	180		MHz	$\label{eq:VCE} \begin{array}{l} V_{CE}=5V,\ I_{C}=10mA,\\ f=100MHz \end{array}$

Note: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



Typical Electrical Characteristics (@TA = +25 °C, unless otherwise specified.)



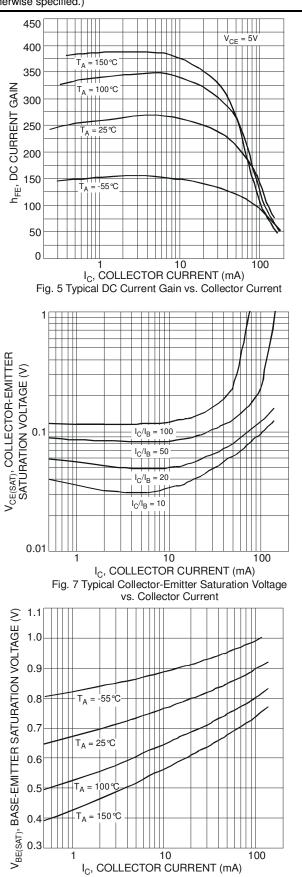


Fig. 9 Typical Base-Emitter Saturation Voltage

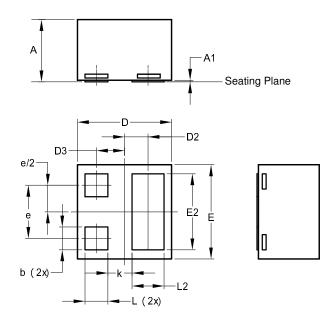
vs. Collector Current

BC847BFZ Document number: DS37157 Rev. 2 - 2



Package Outline Dimensions

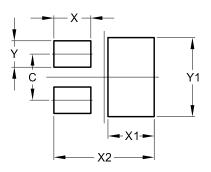
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X2-DFN0606-3					
Dim	Min	Max	Тур		
Α	0.36	0.42	0.39		
A1	0	0.05	0.02		
b	0.10	0.20	0.15		
D	0.57	0.57 0.67 0.62			
D2	0.155 BSC				
D3	0	.185 BS	C		
E	0.57	0.67	0.62		
E2	0.40	0.40 0.60 0.50			
е	0.35 BSC				
k	0.16 REF				
L	0.09	0.21	0.15		
L2	0.11	0.31	0.21		
All	All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.350
Х	0.280
X1	0.350
X2	0.760
Y	0.200
Y1	0.600



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